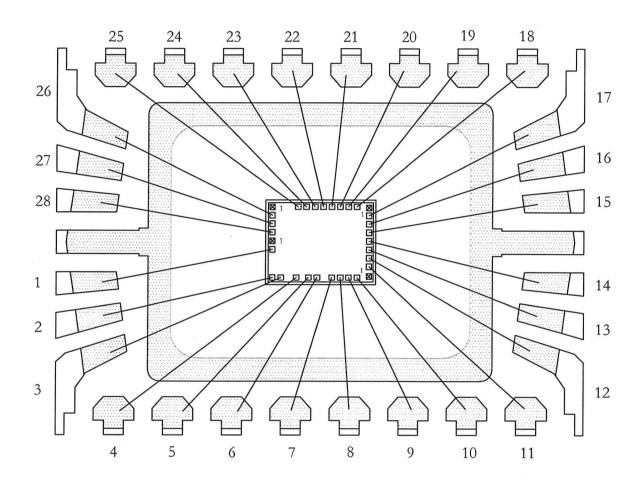
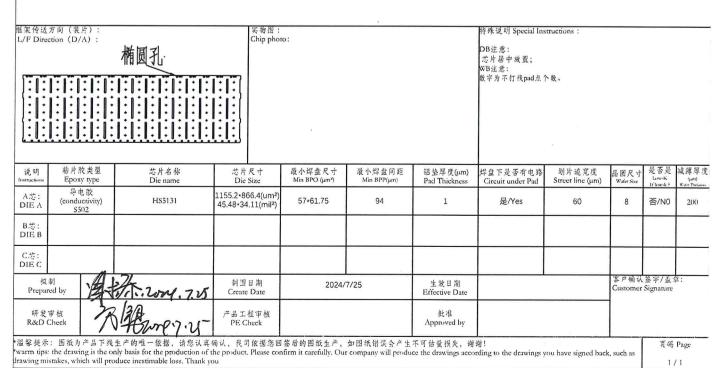
池州华宇电子科技股份有限公司 Hissenii CHI ZHOU HISENII ELECTRONICS TECHNOLOGY CO.,LTD 焊线图纸 Bonding Diagram				客户代码 Customer No.	008	线图号 Drawing No.	HY-PX-008-783 A	
				产品名称 Product Type	HS23P6328 對裝外型 PKG Type		TSSOP28	
焊线种类 Wire Type	焊线直径(μm) Wire Diameter	焊线根数 NO. of wire	焊线总长(μm) Total wire length	最长线长(μm) Longest wire length	最短线长(μm) Shortest wire length	塑封料型号(绿色环保) Compound Type (Green)		LF载体尺寸 LF Pad Size
合金丝 Ag	20	28	60158	2488		首选(Preferred): Cl 备选(Optional):	EL-9220HF	TSSOP28L-8R (120×150mil²) (3048×3810um²)
客户图号 Customer drawin			•					





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